Lighting Color

• Red

LNJ212R8ARA

Surface Mounting Chip LED

TSS Type

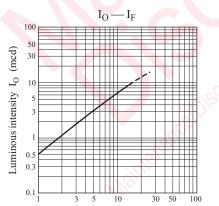
Absolute Maximum Ratings $T_a = 25^{\circ}C$

項目	記号	定格	単位	
Power dissipation	P _D	50	mW	
Forward current	I _F	20	mA	
Pulse forward current *	I _{FP}	60	mA	
Reverse voltage	V _R	3	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

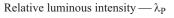
Note) *: The condition of IFP is duty 10%, Pulse width 1 msec.

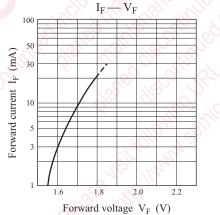
Electro-Optical Characteristics $T_a = 25^{\circ}C$

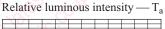
項目	記号	条件	最小	標準	最大	単位
Luminous intensity	I _O	$I_F = 10 \text{ mA}$	2.2	6.7		mcd
Reverse current	I _R	$V_R = 3 V$			100	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$		1.72	2.5	V
Peak emission wavelength	λ_{P}	$I_F = 10 \text{ mA}$	00	655	CO.	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	5	. 20	101	nm

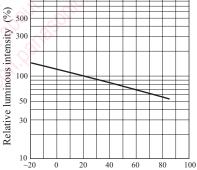


Forward current IF (mA)

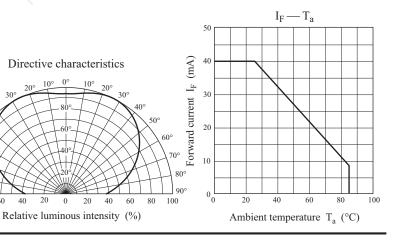








Ambient temperature T_a (°C)



1 0 0 0

Publication date: December 2008

600

Peak emission wavelength λ_P (nm)

650

Relative luminous intensity (%)

100

80

60

40

20

0L

SHD00428BEK

60

80

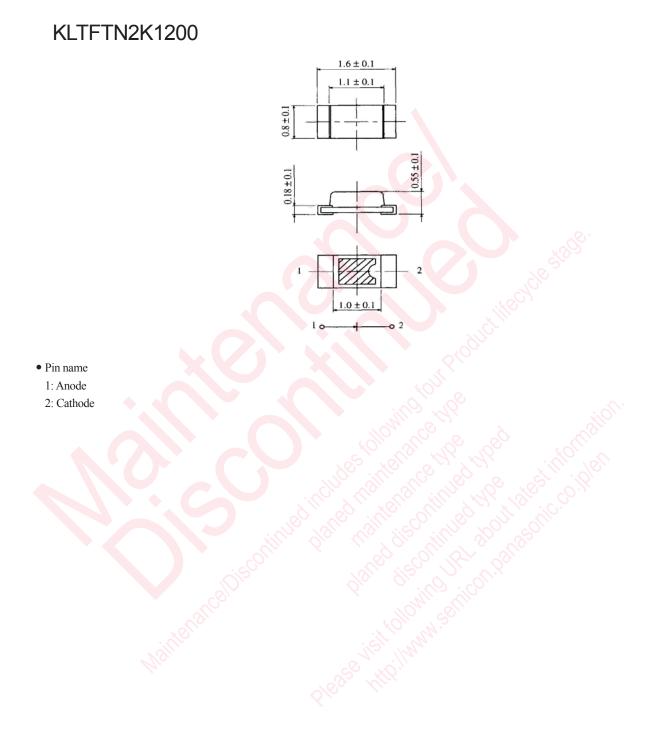
60

80 909

700 100

LNJ212R8ARA

Package (Unit: mm)



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